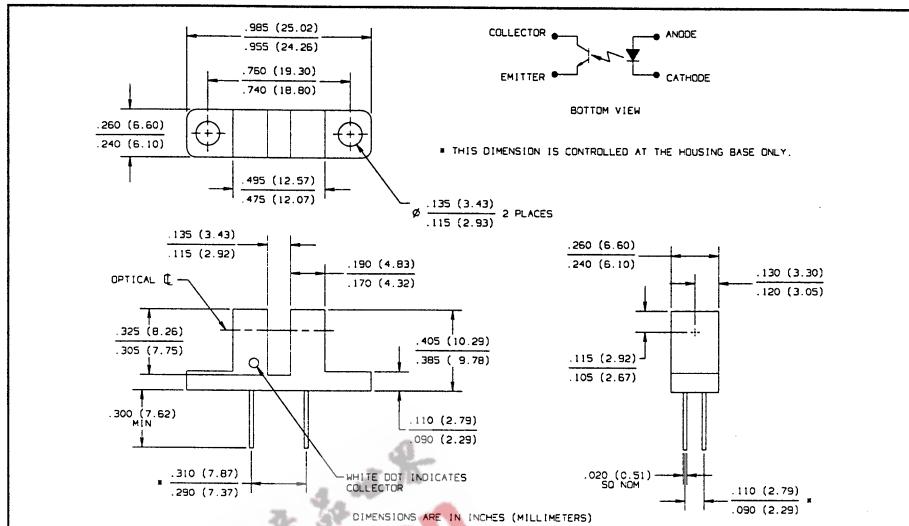
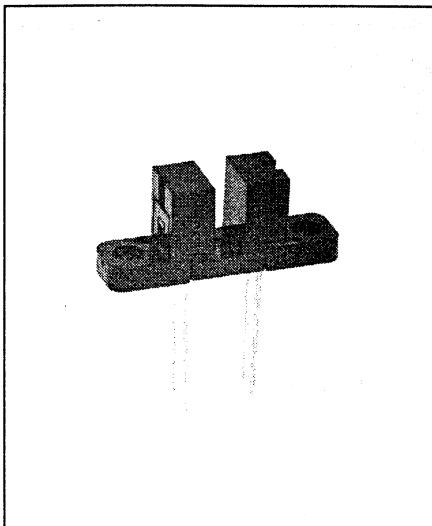


# Slotted Optical Switches

## Types OPB845A, OPB845B



### Features

- Non-contact switching
- Printed circuit board mounting
- 0.125" (3.18 mm) wide slot
- 0.300" (7.62 mm) lead spacing
- Opaque plastic housing

### Description

The OPB845 series consists of an infrared emitting diode and an NPN silicon phototransistor encased in an opaque housing on opposite sides of a .125" (3.18 mm) wide slot. The opaque housing, with molded apertures, provides protection in areas where ambient radiation may be a concern. The "A" option offers a .050" (1.27 mm) wide aperture molded in front of the phototransistor while the "B" version offers a .010" (0.254 mm) wide aperture.

	Phototransistor
OPB#	Aperture Width
OPB845A	0.050"
OPB845B	0.010"

### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

Storage and Operating Temperature Range	-40 $^\circ C$ to +85 $^\circ C$
Lead Soldering Temperature [1/16 inch (1.6 mm) from case for 5 sec. with soldering iron]	240 $^\circ C$ (1)
<b>Input Diode</b>	
Forward DC Current	50 mA
Peak Forward Current (1 $\mu s$ pulse width, 300 pps)	3.0 A
Reverse DC Voltage	2.0 V
Power Dissipation	100 mW(2)

### Output Phototransistor

Collector-Emitter Voltage	30 V
Emitter-Collector Voltage	5.0 V
Collector DC Current	30 mA
Power Dissipation	100 mW(2)

### Notes:

- (1) RMA flux is recommended. Duration can be extended to 10 sec. max. when flow soldering.
- (2) Derate Linearly 1.67 mW/ $^\circ C$  above 25 $^\circ C$ .
- (3) All parameters tested using pulse technique.
- (4) Methanol or isopropanol are recommended as cleaning agents. Plastic housing is soluble in chlorinated hydrocarbons and ketones.

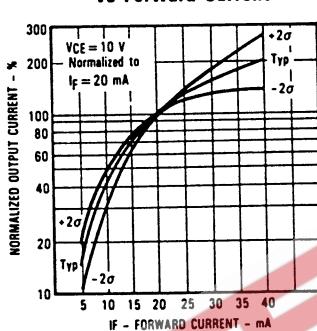
# Types OPB845A, OPB845B

Electrical Characteristics ( $T_A = 25^\circ C$  unless otherwise noted)

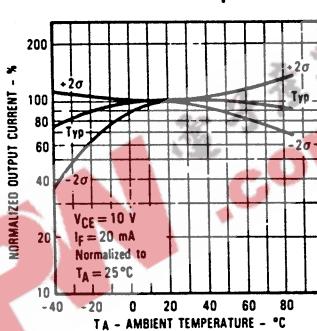
SYMBOL	PARAMETER	MIN	MAX	UNITS	TEST CONDITIONS
<b>Input Diode</b>					
$V_F$	Forward Voltage		1.7	V	$I_F = 20 \text{ mA}$
$I_R$	Reverse Current		100	$\mu\text{A}$	$V_R = 2 \text{ V}$
<b>Output Phototransistor</b>					
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	30		V	$I_C = 1 \text{ mA}$
$V_{(BR)ECO}$	Emitter-Collector Breakdown Voltage	5.0		V	$I_E = 100 \mu\text{A}$
$I_{CEO}$	Collector-Emitter Dark Current		100	nA	$V_{CE} = 10 \text{ V}$ , $I_F = 0$ , $E_e = 0$
<b>Coupled</b>					
$V_{CE(SAT)}$	Saturation Voltage		0.6	V	$I_C = 1800 \mu\text{A}$ , $I_F = 20 \text{ mA}$
$I_{C(ON)}$	On-State Collector Current	1800		$\mu\text{A}$	$V_{CE} = 0.6 \text{ V}$ , $I_F = 20 \text{ mA}$

Typical Performance Curves

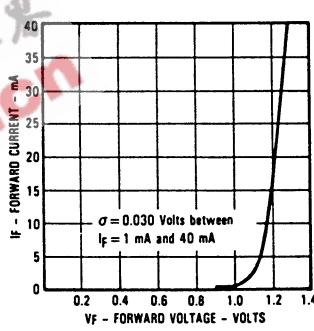
Normalized Output Current vs Forward Current



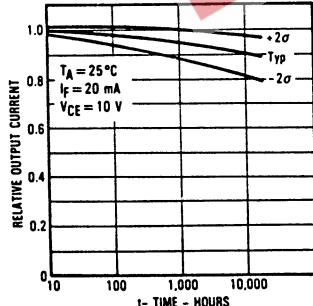
Normalized Output Current vs Ambient Temperature



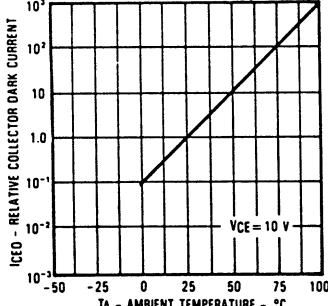
Forward Current vs Forward Voltage Input Diode



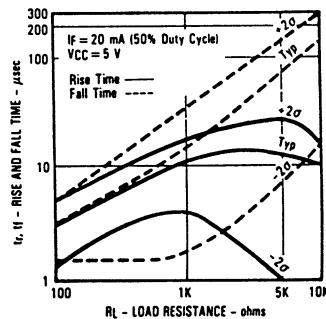
Relative Output Current vs Time



Collector Dark Current vs Ambient Temperature



Rise and Fall Time vs Load Resistance



Reduction in Output Current Due to LED Heating vs Forward Current

